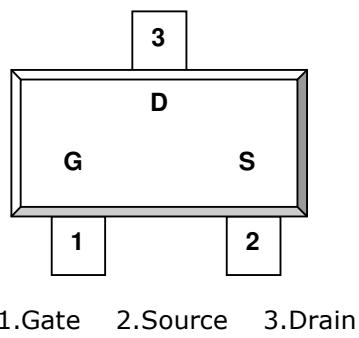


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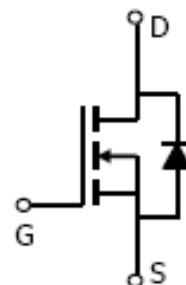
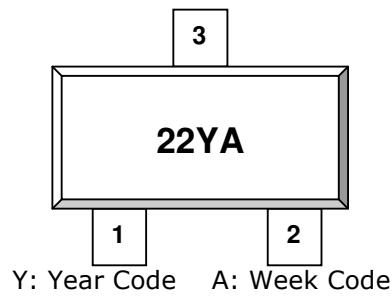
N Channel Enhancement Mode MOSFET

**6.0A****DESCRIPTION**

The 3422A is the N-Channel logic enhancement mode power field effect transistor is produced using high cell density, DMOS trench technology. This high-density process is especially tailored to minimize on-state resistance. These devices are particularly suited for low voltage application such as cellular phone and notebook computer power management and other battery powered circuits where high side switching.

**PIN CONFIGURATION  
SOT-23-3L****FEATURE**

- 60V/6.0A,  $R_{DS(ON)} = 28m\Omega$  (Typ.)  
    @ $V_{GS} = 10V$
- 60V/2.5A,  $R_{DS(ON)} = 38m\Omega$   
    @ $V_{GS} = 4.5V$
- 60V/1.5A,  $R_{DS(ON)} = 100m\Omega$   
    @ $V_{GS} = 2.5V$
- Super high density cell design for extremely low  $R_{DS(ON)}$
- Exceptional on-resistance and maximum DC current capability
- SOT-23-3L package design

**PART MARKING  
SOT-23-3L**

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**ABSOLUTE MAXIMUM RATINGS** (Ta = 25°C Unless otherwise noted )

Parameter	Symbol	Typical	Unit
Drain-Source Voltage	V <sub>DSS</sub>	60	V
Gate-Source Voltage	V <sub>GSS</sub>	±20	V
Continuous Drain Current TJ=150°C	I <sub>D</sub>	6.0 4.6	A
Pulsed Drain Current	I <sub>DM</sub>	20	A
Continuous Source Current (Diode Conduction)	I <sub>S</sub>	1.7	A
Power Dissipation	P <sub>D</sub>	2.0 1.3	W
Operation Junction Temperature	T <sub>J</sub>	-55/150	°C
Storage Temperature Range	T <sub>STG</sub>	-55/150	°C
Thermal Resistance-Junction to Ambient	R <sub>θJA</sub>	75	°C/W

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**ELECTRICAL CHARACTERISTICS ( Ta = 25°C Unless otherwise noted )**

Parameter	Symbol	Condition	Min	Typ	Max	Unit
<b>Static</b>						
Drain-Source Breakdown Voltage	V <sub>(BR)DSS</sub>	V <sub>GS</sub> =0V, I <sub>D</sub> =250uA	60			V
Gate Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =250uA	1		3	V
Gate Leakage Current	I <sub>GSS</sub>	V <sub>DS</sub> =0V, V <sub>GS</sub> =±20V			±100	nA
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> =48V, V <sub>GS</sub> =0V			1	uA
		V <sub>DS</sub> =48V, V <sub>GS</sub> =0V T <sub>J</sub> =55°C			10	
Drain-source On-Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> =10V, I <sub>D</sub> =6.0A V <sub>GS</sub> =4.5V, I <sub>D</sub> =2.5A V <sub>GS</sub> =2.5V, I <sub>D</sub> =1.5A	28 38 100			mΩ
Forward Transconductance	g <sub>fs</sub>	V <sub>DS</sub> =4.5V, I <sub>D</sub> =5.8A		11		S
Diode Forward Voltage	V <sub>SD</sub>	I <sub>S</sub> =1.7A, V <sub>GS</sub> =0V			1.2	V
<b>Dynamic</b>						
Total Gate Charge	Q <sub>g</sub>	V <sub>DS</sub> =15V V <sub>GS</sub> =10V I <sub>D</sub> ≡6.7A		10	22	nC
Gate-Source Charge	Q <sub>gs</sub>			1.8		
Gate-Drain Charge	Q <sub>gd</sub>			3.8		
Input Capacitance	C <sub>iss</sub>	V <sub>DS</sub> =15V V <sub>GS</sub> =0V F=1MHz		455		pF
Output Capacitance	C <sub>oss</sub>			243		
Reverse Transfer Capacitance	C <sub>rss</sub>			38		
Turn-On Time	t <sub>d(on)</sub> tr	V <sub>DD</sub> =15V R <sub>L</sub> =15Ω I <sub>D</sub> =1.0A V <sub>GEN</sub> =10V R <sub>G</sub> =6Ω		8	15	nS
Turn-Off Time	t <sub>d(off)</sub> tf			10	20	
				20	40	
				11	20	

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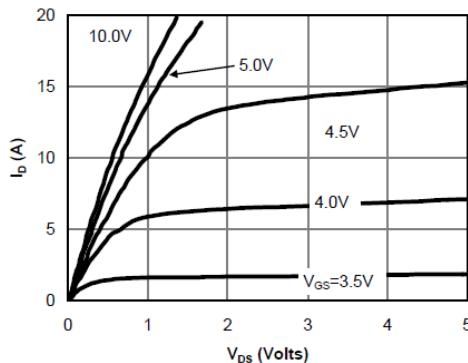
**6.0A****TYPICAL CHARACTERISTICS (25°C Unless noted)**

Fig 1: On-Region Characteristics

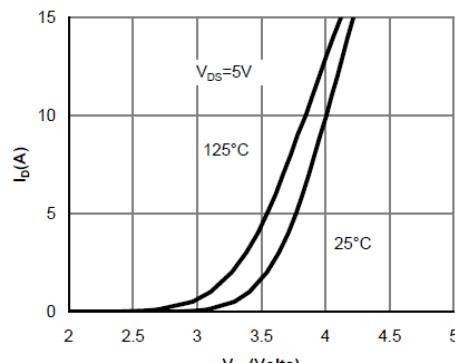


Figure 2: Transfer Characteristics

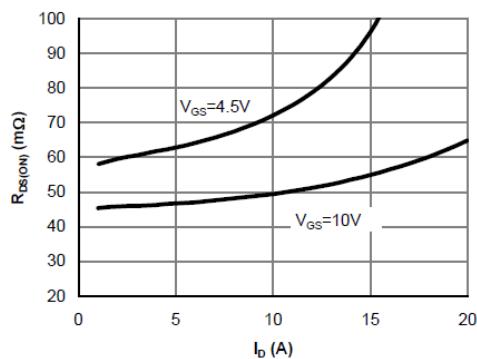


Figure 3: On-Resistance vs. Drain Current and Gate Voltage

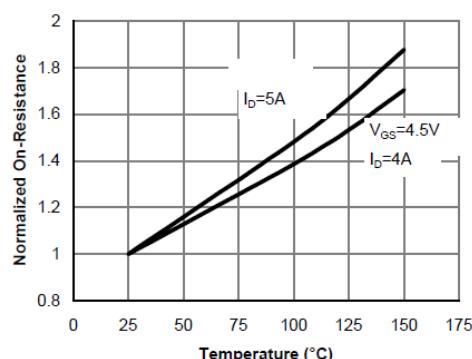


Figure 4: On-Resistance vs. Junction Temperature

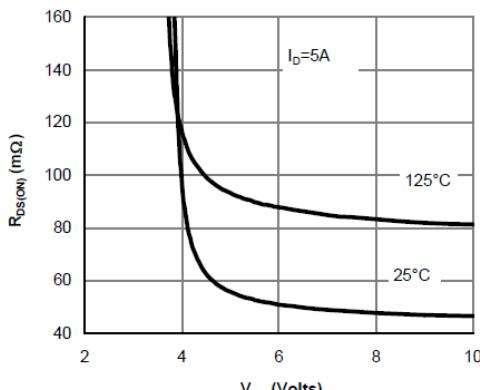


Figure 5: On-Resistance vs. Gate-Source Voltage

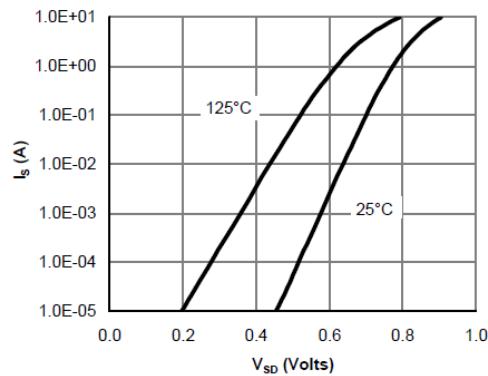


Figure 6: Body-Diode Characteristics

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**TYPICAL CHARACTERISTICS (25°C Unless noted)**

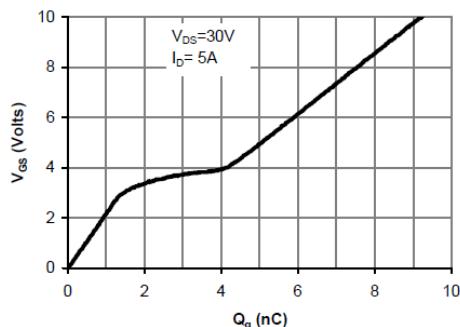


Figure 7: Gate-Charge Characteristics

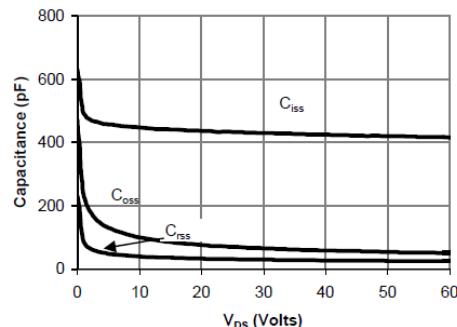


Figure 8: Capacitance Characteristics

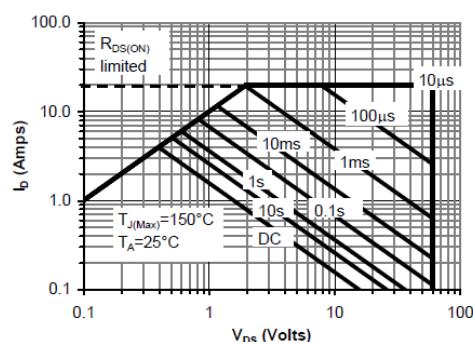


Figure 9: Maximum Forward Biased Safe Operating Area (Note E)

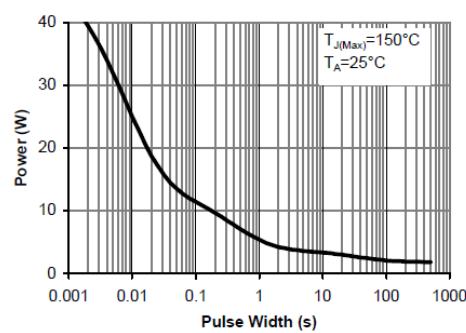


Figure 10: Single Pulse Power Rating Junction-to-Ambient (Note E)

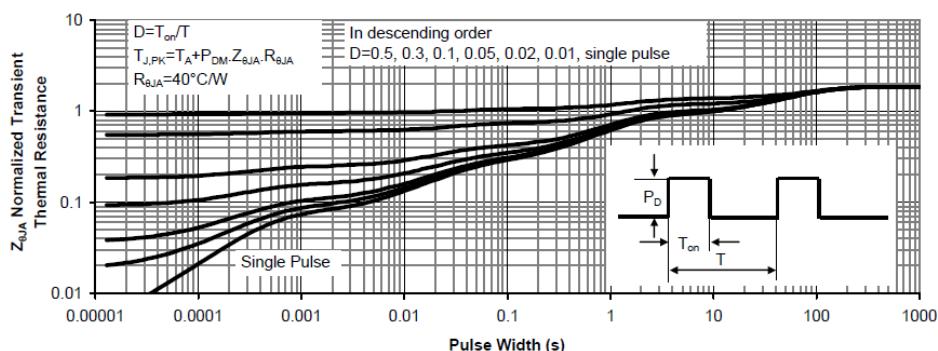


Figure 11: Normalized Maximum Transient Thermal Impedance

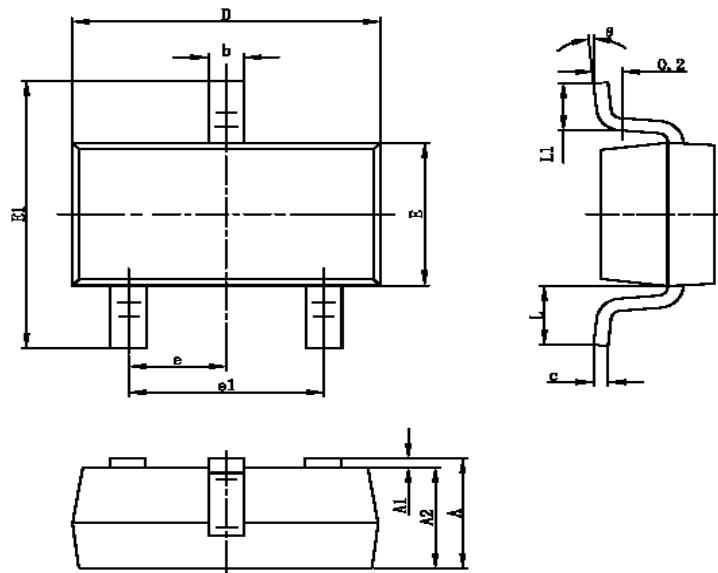
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**SOT-23-3L PACKAGE OUTLINE**



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	1.050	1.250	0.041	0.049
A1	0.000	0.100	0.000	0.004
A2	1.050	1.150	0.041	0.045
b	0.300	0.400	0.012	0.016
c	0.100	0.200	0.004	0.008
D	2.820	3.020	0.111	0.119
E	1.500	1.700	0.059	0.067
E1	2.650	2.950	0.104	0.116
e	0.950TYP		0.037TYP	
e1	1.800	2.000	0.071	0.079
L	0.700REF		0.028REF	
L1	0.300	0.600	0.012	0.024
$\theta$	0°	8°	0°	8°